Unit: mm

# MA2J704 (MA10704)

#### Silicon epitaxial planar type

For super high speed switching

#### Features

- Forward current (Average)  $I_{F(AV)} = 200$  mA rectification is possible
- Small reverse current I<sub>R</sub> (About 1/10 of I<sub>R</sub> of the ordinary products)

1.25±0.1 0.35±0.	<u>0.7±0.1</u>
	0 to 0.1
5' 	
1 : Anode	(0.15)
2 : Cathode EIAJ : SC-76	SMini2-F1 Package

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

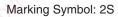
Parameter

	,	0	
Reverse voltage	V <sub>R</sub>	20	V
Repetitive peak reverse voltage	V <sub>RRM</sub>	20	V
Peak forward current	I <sub>FM</sub>	300	mA
Forward current (Average)	I <sub>F(AV)</sub>	200	mA
Non-repetitive peak forward surge current *	I <sub>FSM</sub>	1	A
Junction temperature	Tj	125	°C
Storage temperature	T <sub>stg</sub>	-55 to +125	°C

Symbol

Rating

Unit



Note) \*: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

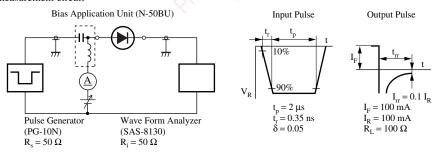
#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage		V <sub>F</sub>	$I_F = 200 \text{ mA}$	02	"Uh	0.55	V
Reverse current		I <sub>R1</sub>	$V_R = 10 V$	20- A	ŝ	2	μΑ
		I <sub>R2</sub>	$V_R = 20 V$	3		5	
Terminal capacitance	, C	C <sub>t</sub>	$V_R = 0 V, f = 1 MHz$	$\mathcal{O}_{\mathcal{X}}$	30		pF
Reverse recovery time *	~ C/V	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$	<i>•</i>	3.0		ns
			$I_{rr} = 0.1 I_R$ , $R_L = 100 \Omega$				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

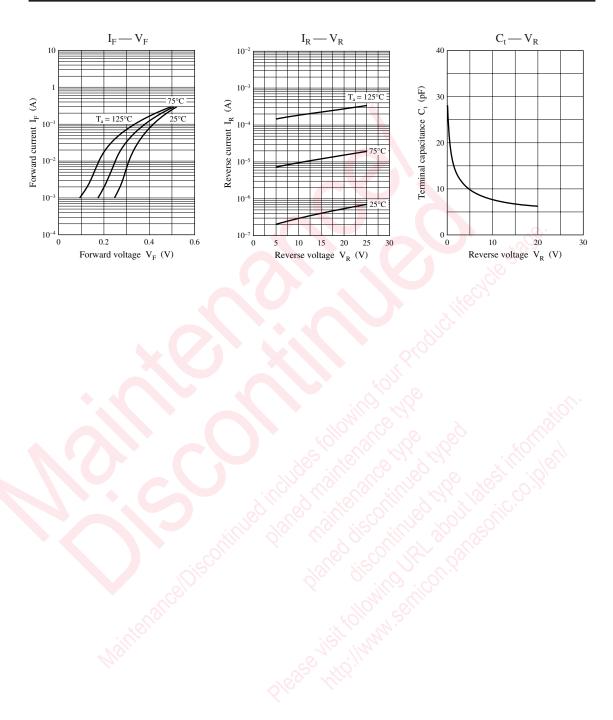
- 3. Absolute frequency of input and output is 1 GHz.
- 4. \*: t<sub>rr</sub> measurement circuit



Note) The part number in the parenthesis shows conventional part number.

#### MA2J704

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